

FORM PTO-1449
(Rev. 7-80)U.S. Department of Commerce
Patent and Trademark Office

Attorney Docket No.

TESSERA 3.0-102 II DIV

Serial No.

LIST OF PRIOR ART CITED BY APPLICANT

(Use several sheets if necessary)

Applicant

Thomas H. DiStefano

Filing Date

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Group

JC836 U.S. PTO
09/16/99

07/27/00

U.S. PATENT DOCUMENTS

*EXAMINER INITIALS		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
<u>A</u>	AA	5,834,339	11/10/98	DiStefano et al.	438	125	
	AB	5,347,159	9/13/94	Khandros et al.	257	692	
	AC	5,557,501	9/17/96	DiStefano et al.	361	704	
	AD	5,124,277	6/92	Tsumura	437	9	
	AE	4,948,221	8/90	Yates	358	96.20	
	AF	5,473,512	12/95	Degani et al.	361	760	
	AG	5,216,278	6/93	Lin et al.	257	688	
	AH	5,717,252	2/98	Nakashima et al.	257	707	
	AI	5,214,307	5/93	Davis	257	676	
	AJ	5,239,198	8/93	Lin et al.	257	693	
<u>G</u>	AK	5,428,889	7/95	Mita et al.	29	827	

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
<u>G</u>	AL	WO 92/05582	4/2/92	WIPO				
	AM							
	AN							
	AO							
	AP							

OTHER PRIOR ART (Including Author, Title, Date, Pertinent Pages, Etc.)

<u>22</u>	AR		Design for Minimum Chip Joint Stress, IBM Technical Disclosure Bulletin, Vol. 32, No. 7, December 1989, pp. 12-13.					
<u>22</u>	AS		Multichip Module Technologies and Alternatives: The Basics, Doane and Franzon, Eds. 1993, pp. 429-430 and 569-613.					
<u>22</u>	AT		Metallurgy For Engineers, E. C. Rollason, Fourth Edition, 1973, pp. 218-220.					

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JMD

DATE CONSIDERED

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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.

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U.S. PATENT DOCUMENTS

*EXAMINER INITIALS		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
G	AA	4,862,322	8/89	Bickford et al.	361	386	
G	AB	5,866,949	2/99	Schueller	257	778	
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
	AM							
	AN							
	AO							
	AP							

OTHER PRIOR ART (Including Author, Title, Date, Pertinent Pages, Etc.)

G	AR		Materials Handbook, Brady et al., Thirteenth Edition, 1991, pp. 487-488.					
G	AS		Multichip Module-Technologies and Alternatives - The Basics: Doane and Franzon, eds. pp. 56-69 DATE NOT AVAILABLE					
	AT							

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GMO

DATE CONSIDERED

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